

10-24-05

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Customer No.: 07278

Docket No.: 09864/0202607-US0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Takashi Nakai et. al.

Serial No.: 10/531,813

Filed: April 18, 2005

For: METHOD FOR FORMING COMPACT FROM POWDER AND MOLD APPARATUS FOR POWDER MOLDING

REQUEST FOR CORRECTED FILING RECEIPT

EXPRESS MAIL CERTIFICATE

69213262068

Date 10/21/05 Label No. EV
I hereby certify that, on the date indicated above, this paper or fee was deposited with the U.S. Postal Service & that it was addressed for delivery to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 by "Express Mail Post Office to Addressee" service.

X. S. Nakai 1.87antus
Name (Print) Signature

Sir:

- Attached is a copy of the official filing receipt received from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested.
- There is an error with respect to the following data, which is:

- incorrectly entered
 omitted.
and/or

| Error in | Correct data |
|---|---|
| <input type="checkbox"/> Applicant's name | |
| <input checked="" type="checkbox"/> Applicant's address | Takashi Nakai, Niigata-shi, Japan Kinya Kawase, Niigata-shi, Japan |
| <input checked="" type="checkbox"/> Title | METHOD FOR FORMING COMPACT FROM POWDER AND MOLD APPARATUS FOR POWDER MOLDING |
| <input type="checkbox"/> Filing Date | |
| <input type="checkbox"/> Application Number | |
| <input type="checkbox"/> Foreign/PCT Application Re: | |
| <input type="checkbox"/> Other | |

Remarks:

Enclosed please find a copy of the Application Data Sheet.

The Commissioner is respectfully requested to issue a new and correct Filing Receipt.

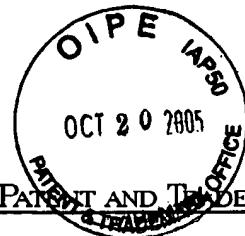
Respectfully submitted,

Dated: October 20, 2005



Flynn Barrison
Reg. No. 53,970
Agent for Applicant(s)

DARBY & DARBY P.C.
P.O. Box 5257
New York, New York 10150-5257
212-527-7700


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| APPL NO. | FILING OR 371 (c) DATE | ART UNIT | FIL FEE REC'D | ATTY DOCKET NO | DRAWINGS | TOT CLMS | IND CLMS |
|------------|---------------------------|----------|---------------|-------------------|----------|----------|----------|
| 10/531,813 | 04/18/2005 | 1775 | 900 | 09864/0202607-US0 | 3 | 18 | 1 |

CONFIRMATION NO. 3685

7278
 DARBY & DARBY P.C.
 P. O. BOX 5257
 NEW YORK, NY 10150-5257

FILING RECEIPT


OC000000017149162

Date Mailed: 10/06/2005

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Takashi Nakai, Niigata, JAPAN;
 Kinya Kawase, Niigata, JAPAN;

Assignment For Published Patent Application

Mitsubishi Materials Corporation, Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 7278.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP03/14643 11/18/2003

Foreign Applications

JAPAN 2002-338621 11/21/2002

Projected Publication Date: To Be Determined - pending completion of Security Review

Non-Publication Request: No

Early Publication Request: No

Title

Computer None
 D&D Entry None
 Looseleaf None
 Folder None
 Card None
 Letter None
 Foreign Flg. None

Method for forming compact from powder and mold apparatus for powder forming**Preliminary Class**

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Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Group Art Unit:: N/A
CD-ROM or CD-R?:: None
Sequence submission?:: None
Computer Readable Form (CRF)?:: No
Title:: METHOD FOR FORMING COMPACT
FROM POWDER AND MOLD APPARATUS
FOR POWDER MOLDING (AS AMENDED)
Attorney Docket Number:: 09864/0202607-US0
Request for Early Publication?:: No
Request for Non-Publication?:: No
Suggested Drawing Figure:: Fig. 1
Total Drawing Sheets:: 3
Small Entity?:: No
Petition included?:: No
Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Takashi
Family Name:: Nakai
City of Residence:: Niigata-shi
Country of Residence:: Japan
Street of mailing address:: c/o Mitsubishi Materials Corporation Niigata
Plant
1-1, Koganecho 3-chome

City of mailing address:: Niigata-shi
State or Province of mailing address:: Niigata
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 950-8640

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Kinya
Family Name:: Kawase
City of Residence:: Niigata-shi
Country of Residence:: Japan
Street of mailing address:: c/o Mitsubishi Materials Corporation Niigata
Plant
1-1, Kogane-cho 3-chome
City of mailing address:: Niigata-shi
State or Province of mailing address:: Niigata
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 950-8640

Correspondence Information

Correspondence Customer Number:: 07278

Representative Information

Representative Customer Number:: 07278

Domestic Priority Information

| Application:: | Continuity Type:: | Parent Application:: | Parent Filing Date:: |
|------------------|-------------------|----------------------|----------------------|
| This Application | National Stage of | PCT/JP2003/014643 | 11/18/03 |

Foreign Priority Information

| Country:: | Application number:: | Filing Date:: | Priority Claimed:: |
|-----------|----------------------|---------------|--------------------|
| Japan | 2002-338621 | 11/21/02 | No |

Assignee Information

Assignee name:: Mitsubishi Materials Corporation
Street of mailing address:: 5-1, Ohtemachi 1-chome
Chiyoda-ku,
City of mailing address:: Tokyo
Country of mailing address:: Japan